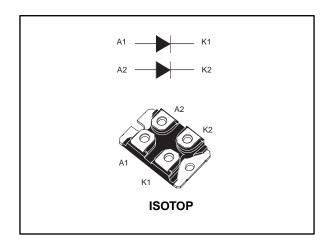


# STPS200170TV1

## High voltage power Schottky rectifier

Datasheet - production data



### **Features**

- Negligible switching losses
- Avalanche rated
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Insulated package ISOTOP:
  - Insulated voltage: 2500 V<sub>RMS</sub>
  - Capacitance: 45 pF

## **Description**

This high voltage Schottky rectifier is suited for high frequency switch mode power supplies.

Packaged in ISOTOP, this device is intended for use in the secondary rectification of applications.

**Table 1: Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	2 x 100 A
V <sub>RRM</sub>	170 V
T <sub>j</sub> (max.)	150 °C
V <sub>F</sub> (max.)	0.63 V

This is information on a product in full production.

Characteristics STPS200170TV1

## 1 Characteristics

Table 2: Absolute ratings (limiting values, per diode at T<sub>amb</sub> = 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage			170	V
I <sub>F(RMS)</sub>	Forward rms current			200	
I <sub>F(AV)</sub>	Average forward current, $\delta$ = 0.5 $T_C$ = 105 °C Per diode			100	Α
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			700	Α
Parm	Repetitive peak avalanche power $t_p = 10 \mu s T_j = 125 °C$			7400	W
T <sub>stg</sub>	Storage temperature range			-55 to +150	°C
Tj	Maximum operating junction temperature <sup>(1)</sup>			150	°C

### Notes:

**Table 3: Thermal parameters** 

Symbol	Parameter		Maximum values	Unit
D. a. s	Junction to case	Per diode	0.52	
R <sub>th(j-c)</sub>	Junction to case	Total	0.31	°C/W
R <sub>th(c)</sub>	Coupling thermal resistance		0.1	

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_j \text{ (diode1)} = P_{\text{(diode1)}} x R_{\text{th(j-c) (per diode)}} + P_{\text{(diode2)}} x R_{\text{th(c)}}$ 

**Table 4: Static electrical characteristics** 

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	(1) Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		200	μΑ
IR <sup>(*)</sup>		T <sub>j</sub> = 125 °C		-	30	100	mA
	V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 100 A	-		0.85	
V (2)		T <sub>j</sub> = 150 °C		-	0.63	0.68	V
VF <sup>(2)</sup> FC		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 200 A	-		0.975	V
		T <sub>j</sub> = 150 °C		-	0.78	0.86	

### Notes:

 $^{(1)} Pulse$  test:  $t_p$  = 5 ms,  $\delta < 2\%$ 

(2) Pulse test:  $t_p = 380 \mu s$ ,  $\delta < 2\%$ 

To evaluate the maximum conduction losses, use the following equation:

 $P = 0.5 \text{ x } I_{F(AV)} + 0.0018 \text{ x } I_{F^{2}(RMS)}$ 

 $<sup>^{(1)}(</sup>dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

STPS200170TV1 Characteristics

## 1.1 Characteristics (curves)

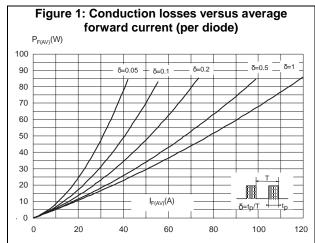
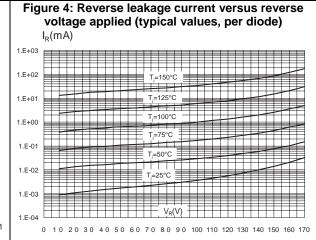
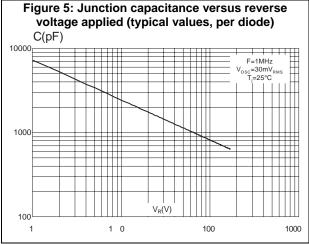
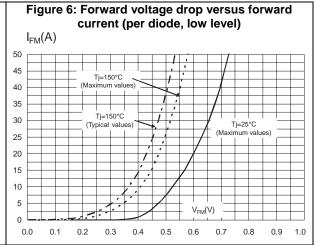


Figure 2: Average forward current versus ambient temperature ( $\delta$  = 0.5, per diode) 120 100 80 60 40 20 T<sub>amb</sub> (°C) 0 0 25 50 100 125 150

Figure 3: Relative variation of thermal impedance (junction to case) versus pulse duration  $Z_{th(j-c)}/R_{th(j-c)}$ 1.0 0.9 0.8 0.7 0.6 δ=0.5 0.5 0.4 0.3 0.2 0.1  $t_P(s)$ 0.0 1.E-04







Characteristics STPS200170TV1

Figure 7: Forward voltage drop versus forward current (per diode, high level)

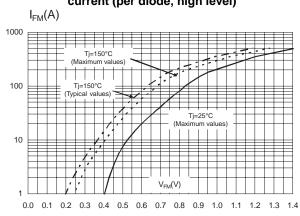
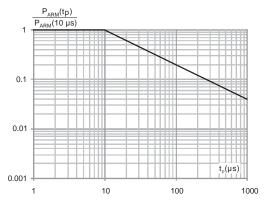


Figure 8: Normalized avalanche power derating versus pulse duration



4/8 DocID11857 Rev 3

STPS200170TV1 Package information

#### 2 **Package information**

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 1.3 N·m
- Maximum torque value: 1.5 N·m

STMicroelectronics strongly recommends the use of the screws delivered with this product.

The use of any other screws is entirely at the user's own risk and will invalidate the warranty.

#### **ISOTOP** package information 2.1

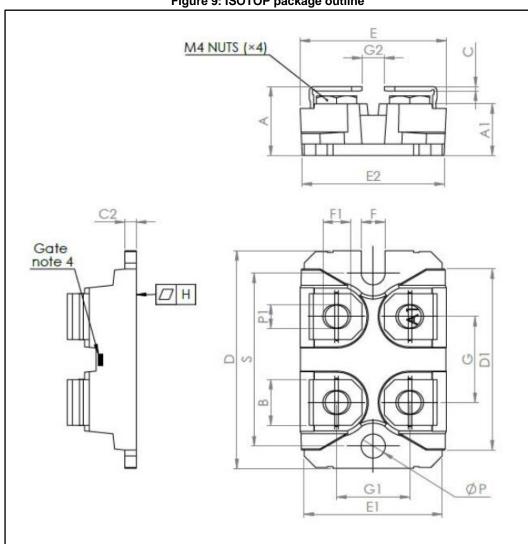


Figure 9: ISOTOP package outline

577

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DocID11857 Rev 3

5/8

Package information STPS200170TV1

Table 5: ISOTOP package mechanical data

	Dimensions				
Ref.	Millir	neters	Inch	Inches	
	Min.	Max.	Min.	Max.	
А	11.80	12.20	0.465	0.480	
A1	8.90	9.10	0.350	0.358	
В	7.80	8.20	0.307	0.323	
С	0.75	0.85	0.030	0.033	
C2	1.95	2.05	0.077	0.081	
D	37.80	38.20	1.488	1.504	
D1	31.50	31.70	1.240	1.248	
E	25.15	25.50	0.990	1.004	
E1	23.85	24.15	0.939	0.951	
E2	24	1.80	0.976		
G	14.90	15.10	0.587	0.594	
G1	12.60	12.80	0.496	0.504	
G2	3.50	4.30	0.138	0.169	
F	4.10	4.30	0.161	0.169	
F1	4.60	5	0.181	0.197	
Н	-0.05	0.1	-0.002	0.004	
Diam P	4	4.30	0.157	0.169	
P1	4	4.40	0.157	0.173	
S	30.10	30.30	1.185	1.193	

# 3 Ordering information

**Table 6: Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS200170TV1	STPS200170TV1	ISOTOP	27 g (without screws)	10 (with screws)	Tube

# 4 Revision history

**Table 7: Document revision history** 

Date	Revision	Changes
14-Nov-2005	1	First issue.
09-Sep-2011	2	Updated $V_F$ max at $T_j$ = 25 °C and $I_F$ = 100 A to 0.85 V.
12-Feb-2018	3	Updated <i>Table 2: "Absolute ratings (limiting values, per diode at Tamb = 25 °C, unless otherwise specified)"</i> and the new PARM curve at 10 μs.

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